

# SMB1N-850DS-02

- IR High Power LED
- 850 nm, 1.4 W
- SMD package, PA9T
- Dimension: 5.0 x 5.2 x 5.5 mm
- Viewing Angle: 20°

### Description





Rev. 2.0, 07.06.2019

SMB1N-850DS-02 is a surface mount AlGaAs High Power LED with a typical peak wavelength of 850 nm and radiation of 1.4 W. It comes in SMD package (PA9T) with silver plated soldering pads (lead free solderable), copper heat sink, and molded with silicone resin.

### Maximum Ratings (T<sub>CASE</sub>=25°C)

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Parameter	Symbol	Min.	Max.	Unit	
Power Dissipation	PD		4200	mW	
Forward Current	lF		1	А	
Pulse Forward Current *1	IFP		5	А	
Reverse Voltage	VF		5	V	
Thermal Resistance	<i>R</i> тнја		10	K/W	
Junction Temperature	$T_J$		120	°C	
Operating Temperature	TCASE	- 40	+ 100	°C	
Storage Temperature	Tstg	- 40	+ 100	°C	
Lead Solder Temperature *2	T <sub>SLD</sub>		+ 250	°C	

\*1 duty=1%, pulse width = 10  $\mu$ s

\*2 must be completed within 5 seconds

# Electro-Optical Characteristics (TCASE=25°C)

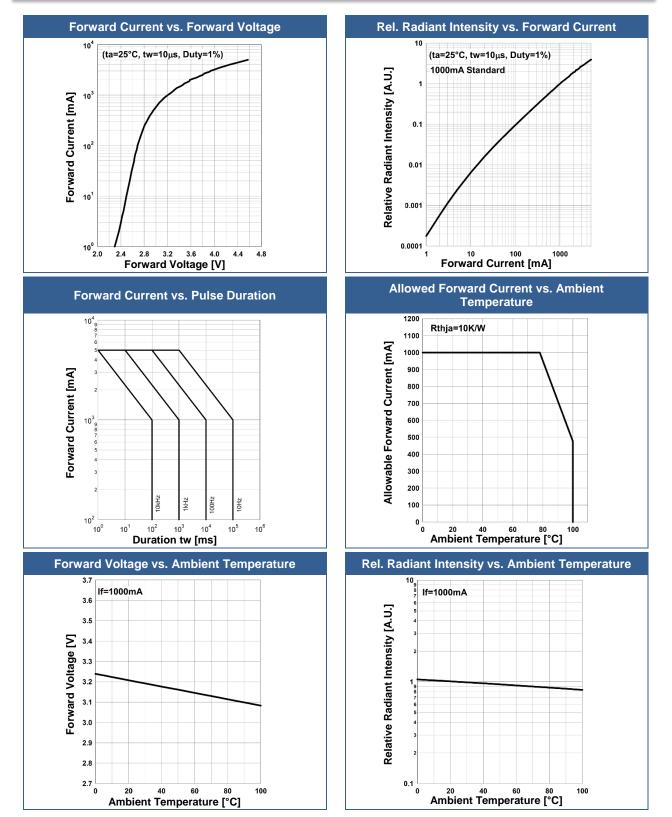
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	$\lambda_P$	I <sub>F</sub> =1A	840		860	nm
Half Width	$\Delta \lambda$	I <sub>F</sub> =1A		33		nm
Forward Voltage	VF	I <sub>F</sub> =1A		3.2	(4.2)	V
	VFP	IFP=3A		4.0		
Radiated Power *1	Po	I <sub>F</sub> =1A		1.4		W
	FO	IFP=3A		3.7		
Radiant Intensity *2	IE	I <sub>F</sub> =1A		6000		mW/sr
	ΤE	IFP=3A		16000		
Viewing Angle	φ	I <sub>F</sub> =100mA		20		deg.
Rise Time	t <sub>R</sub>	I <sub>F</sub> =1A		30		ns
Fall Time	t <sub>F</sub>	I <sub>F</sub> =1A		30		ns

\*1 measured by S3584-08

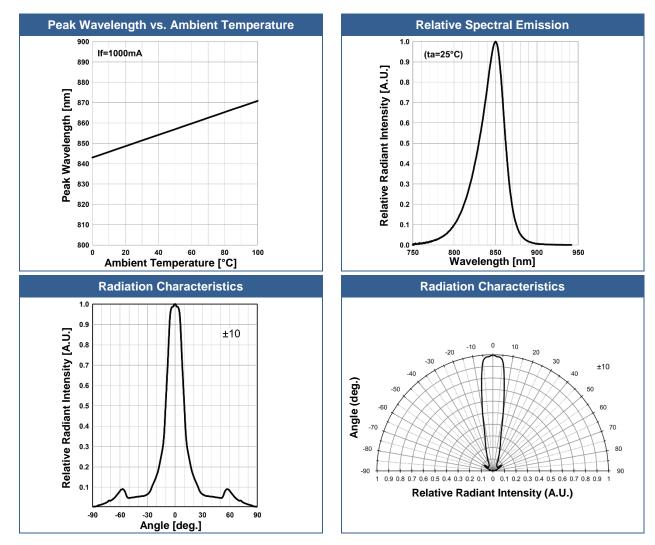
\*2 measured by CIE127-2007 Condition B



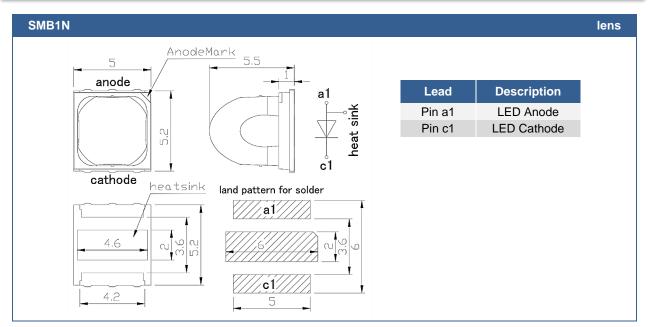
# **Typical Performance Curves**







# **Outline Dimensions**



All Dimensions in mm



### Precautions

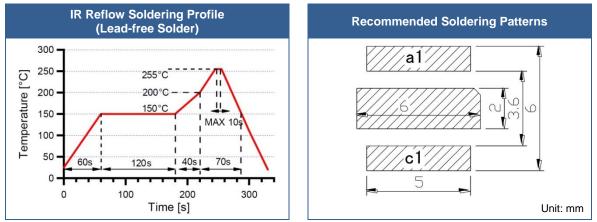
#### Soldering:

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

#### **Recommended soldering conditions:**

This LED is designed to be reflow soldered on to a PCB. If dip soldered or hand soldered, its reliability cannot be guarantee.

Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.



Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

#### **Cleaning:**

#### Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS DO NOT USE ultrasonic cleaners

#### **Static Electricity:**

**LEDs are sensitive to electrostatic discharge (ESD)**. Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

#### Radiation:

During operation these LEDs do emit **high intensity light**, which is hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. **Protective glasses are recommended**. It is further advised to attach a warning label on products/systems.

#### **Operation:**

#### Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

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